

# **Film Capacitors**

Metallized Polypropylene Film Capacitors (MKP)

Series/Type: B32320I Ordering code: B32320I\*

Date: October 2020

Version: V1.0

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# **Metallized Polypropylene Film Capacitors (MKP)**

**B32320I** 

#### **Typical applications**

- Frequency converters
- Inverter based home appliances
- Solar inverters
- Variable speed motor drives

#### **Climatic**

- Max. operating temperature: 105 °C (Hotspot)
- Climatic category (IEC 60068-1:2013): 40/085/56

#### Construction

- Dielectric: Polypropylene (MKP)
- Plastic case (UL 94 V-0)
- Epoxy resin sealing (UL 94 V-0)

#### **Features**

- Capacitance values 6.5 up to 260 µF
- High CV product, compact
- Good self-healing properties
- Over-voltage capability
- Low losses with high current capability
- High reliability
- Long useful life
- RoHS-compatible

#### **Terminals**

- Parallel wire leads, lead-free tinned
- 5-pin
- Standard lead lengths: 4.5 ±0.5 mm

#### **Marking**

Manufacturer's logo and lot number, date code, rated capacitance (coded), capacitance tolerance (code letter) and rated DC voltage

#### **Delivery mode**

Bulk (untaped)





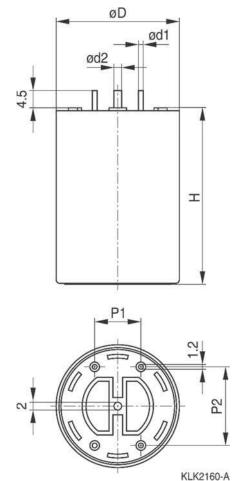
# **Metallized Polypropylene Film Capacitors (MKP)**

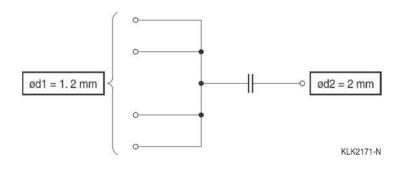
B32320I

# **Dimensional drawings**

| Number of wires | Lead spacing (P1) mm | Lead pacing (P2)<br>mm | Lead diameter (d1) mm | Lead diameter (d2)<br>mm | Туре    |
|-----------------|----------------------|------------------------|-----------------------|--------------------------|---------|
| 5-pin           | 12.7 ±0.4            | 22.5 ±0.4              | 1.2 ±0.05             | 2.0 ±0.05                |         |
| 5-pin           | 16 ±0.4              | 37.5 ±0.4              | 1.2 ±0.05             | 2.0 ±0.05                | B32320I |
| 5-pin           | 20.3 ±0.4            | 42.5 ±0.4              | 1.2 ±0.05             | 2.0 ±0.05                |         |

# **Dimensional drawings 5-pin version**





**Note**: 4 × 1.2 mm terminal-electrode (d1)

1 × 2 mm terminal-electrode (d2)



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# Overview of available types

| V <sub>R</sub> (85 °C) | 450 V DC | 800 V DC | 1100 V DC | 1300 V DC |
|------------------------|----------|----------|-----------|-----------|
| C <sub>R</sub> (µF)    |          |          |           |           |
| 6.5                    |          |          |           |           |
| 9.5                    |          |          |           |           |
| 15                     |          |          |           |           |
| 20                     |          |          |           |           |
| 21                     |          |          |           |           |
| 27                     |          |          |           |           |
| 30                     |          |          |           |           |
| 50                     |          |          |           |           |
| 66                     |          |          |           |           |
| 70                     |          |          |           |           |
| 88                     |          |          |           |           |
| 100                    |          |          |           |           |
| 100                    |          |          |           |           |
| 110                    |          |          |           |           |
| 150                    |          |          |           |           |
| 150                    |          |          |           |           |
| 200                    |          |          |           |           |
| 200                    |          |          |           |           |
| 260                    |          |          |           |           |



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## Ordering codes and packing units

| C <sub>R</sub> <sup>1)*)</sup> | Max.<br>dimensions<br>D × H | P1/P2     | Ordering code<br>(composition see<br>below) | I <sub>RMS, max.<sup>2)</sup><br/>60 °C Amb.<br/>10 kHz</sub> | Î <sub>peak</sub> | ESR <sub>typ</sub> | ESL <sub>typ</sub> <sup>3)</sup> | tanδ<br>max.<br>1 kHz<br>(10- <sup>3</sup> ) | Pcs./<br>Pkg. |
|--------------------------------|-----------------------------|-----------|---|---|-------------------|--------------------|----------------------------------|--|---------------|
| μF                             | mm                          | mm        |   | A <sub>RMS</sub>  | kA                | mΩ                 | nH                               |  |               |
| V <sub>R,85</sub>              | °c = 450 V D0               |           |   |   |                   |                    |                                  |  |               |
| 20                             | 35 × 53                     | 22.5/12.7 | B32320I4206K000                             | 20  | 0.4               | 3.8                | 30                               | 1.0  | 84            |
| 27                             | 35 × 53                     | 22.5/12.7 | B32320I4276K000                             | 20  | 0.54              | 4.0                | 30                               | 1.2  | 84            |
| 88                             | 50 × 57                     | 37.5/16.0 | B32320I4886K000                             | 27.6  | 1.75              | 2.4                | 35                               | 1.7  | 32            |
| 200                            | 50 × 95                     | 37.5/16.0 | B32320I4207K000                             | 25  | 1.4               | 4.0                | 60                               | 5.5  | 32            |
| 260                            | 50 × 120                    | 37.5/16.0 | B32320I4267K000                             | 23  | 1.56              | 5.0                | 75                               | 8.0  | 32            |
| V <sub>R,85</sub>              | 5 °C = 800 V D              | С         |   |   |                   |                    |                                  |  |               |
| 15                             | 35 × 53                     | 22.5/12.7 | B32320I8156K000                             | 20  | 0.33              | 3.8                | 30                               | 1  | 84            |
| 50                             | 50 × 57                     | 37.5/16.0 | B32320I8506K000                             | 26.5  | 1.1               | 3.2                | 35                               | 1.5  | 32            |
| 110                            | 50 × 95                     | 37.5/16.0 | B32320I8117K000                             | 22  | 1.0               | 5.0                | 60                               | 4.3  | 32            |
| 150                            | 50 × 120                    | 37.5/16.0 | B32320I8157K000                             | 23  | 1.1               | 5.0                | 75                               | 6.15   | 32            |
| 200                            | 60 × 120                    | 42.5/20.3 | B32320I8207K000                             | 27.5  | 1.5               | 3.6                | 75                               | 6.15   | 21            |
| V <sub>R,85</sub>              | 5 °C = 1100 V [             | OC .      |   |   |                   |                    |                                  |  |               |
| 9.5                            | 35 × 53                     | 22.5/12.7 | B32320I0955K000                             | 16.4  | 0.38              | 5.2                | 30                               | 1  | 84            |
| 30                             | 50 × 57                     | 37.5/16.0 | B32320I0306K000                             | 22.5  | 1.2               | 4.0                | 35                               | 1.2  | 32            |
| 70                             | 50 × 95                     | 37.5/16.0 | B32320I0706K000                             | 23  | 1.4               | 4.7                | 60                               | 3.5  | 32            |
| 100                            | 50 × 120                    | 37.5/16.0 | B32320I0107K000                             | 23  | 1.5               | 5.0                | 75                               | 4.5  | 32            |
| 150                            | 60 × 120                    | 42.5/20.3 | B32320I0157K000                             | 22.4  | 2.2               | 4.3                | 75                               | 5.3  | 21            |
| V <sub>R,85</sub>              | 5°C = 1300 V [              | OC .      |   |   |                   |                    |                                  |  |               |
| 6.5                            | 35 × 53                     | 22.5/12.7 | B32320I1655K000                             | 16.4  | 0.39              | 4.9                | 30                               | 1.0  | 84            |
| 21                             | 50 × 57                     | 37.5/16.0 | B32320I1216K000                             | 20  | 1.26              | 5.0                | 35                               | 1.2  | 32            |
| 50                             | 50 × 95                     | 37.5/16.0 | B32320I1506K000                             | 24  | 1.5               | 4.0                | 60                               | 2.4  | 32            |
| 66                             | 50 × 120                    | 37.5/16.0 | B32320I1666K000                             | 23  | 1.65              | 5.0                | 75                               | 3.9  | 32            |
| 100                            | 60 × 120                    | 42.5/20.3 | B32320I1107K000                             | 22.4  | 2.5               | 4.3                | 75                               | 3.2  | 21            |

<sup>\*)</sup> Intermediate capacitance values are available on request

#### Composition of ordering code

+ = Capacitance tolerance code \*\*\*\* = Packing code  $K = \pm 10\%$  000 = Untapped

000 = Untapped (lead length 4.5 mm)

Other lead lengths can be made available on request

<sup>1)</sup> Capacitance value measured at 1 kHz

<sup>2)</sup> Max ripple current I<sub>RMS</sub>@60 °C Amb@10 kHz for a  $\Delta$ T ≤25 °C at  $\Delta$ ESR<sub>typ</sub> ≤  $\pm$ 5%

<sup>3)</sup> Typical ESL value are calculated out of the resonance frequency (See specific graphs of Z versus frequency)



# **Metallized Polypropylene Film Capacitors (MKP)**

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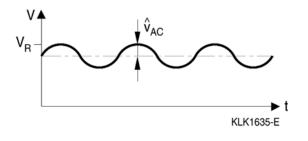
#### **Technical data**

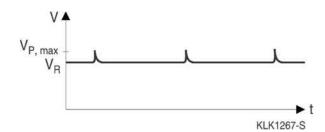
Reference standard: IEC 61071: 2007.

All data given at T=20 °C, unless otherwise is specified.

| Operating temperature range  | Max. operating temperature,                                | THot Spot, max              | +105 °C |  |
|--|--|-----------------------------|---------|--|
|  | Upper category temperature                                 | T <sub>max.</sub>           | +85 °C  |  |
|  | Lower category temperature                                 | T <sub>min.</sub>           | -40 °C  |  |
| Insulation Resistance R <sub>INS</sub> , given as                    | τ >10 000 s (after 1 min)                                  |                             |         |  |
| time constant $\tau = C_R \cdot R_{INS}$ , rel. humidity $\leq 65\%$ | For V <sub>R</sub> ≥500 V measured at 5                    | 00 V                        |         |  |
| (minimum as-delivered values)  | For V <sub>R</sub> <500 V measured at V <sub>R</sub>       |                             |         |  |
| DC voltage test between terminals (10 s)                             | 1.5 • V <sub>R</sub>                                       |                             |         |  |
| Voltage test terminal to case (10 s)                                 | 2110 V AC, 50Hz  |                             |         |  |
| Reliability: Failure rate $\lambda$                                  | 75 fit (≤1 • 10-9) at 0.5 • V <sub>R</sub> , 40 °C         |                             |         |  |
|  | For conversion to other operatemperatures, refer to chapte |                             |         |  |
| Service life t <sub>SL</sub>   | 100 000 h at V <sub>R</sub> , 70 °C                        |                             |         |  |
| $\overline{V_{R (DC)}}$  | 450 V 800 V  | 1100 V                      | 1300 V  |  |
| Continuous operation voltage (Vop) at Top of 85 °C                   | 450 V 800 V  | 1100 V                      | 1300 V  |  |
| For temperatures between 85 °C and 105 °C                            | 2.5% / °C of V <sub>op</sub> derating com                  | pared to V <sub>op</sub> at | : 85 °C |  |

Typical waveforms:







## **Metallized Polypropylene Film Capacitors (MKP)**

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#### Restrictions

 $V_R$ : Maximum operating peak voltage of either polarity but of a non-reversing waveform, for which the capacitor has been designed for continuous operation.

û<sub>AC.</sub> max ≤0.2 • V<sub>R</sub>

| Overvoltage           | Maximum duration within one day | Observation       |
|-----------------------|---------------------------------|-------------------|
| 1.1 • V <sub>R</sub>  | 30 % of on-load duration        | System regulation |
| 1.15 • V <sub>R</sub> | 30 min                          | System regulation |
| 1.2 • V <sub>R</sub>  | 5 min                           | System regulation |
| 1.3 • V <sub>R</sub>  | 1 min                           | System regulation |

#### NOTE 1

An overvoltage equal to  $1.5 \cdot V_R$  for 30 ms is permitted 1000 times during the life of the capacitor.

The amplitudes of the overvoltages that may be tolerated without significant reduction in the life time of the capacitor depend on their duration, the number of application and the capacitor temperature.

In addition, these values assume that the overvoltages may appear when the internal temperature of the capacitor is less than 0 °C but within the temperature category.

#### NOTE 2

The average applied voltage must not be higher than the specified voltage.

# Pulse handling capability

"dV/dt" represents the maximum permissible voltage change per unit of time for non-sinusoidal voltages, expressed in V/ms.

#### Note:

The values of dV/dt provided below must not be exceeded in order to avoid damaging the capacitor.

#### dV/dt values (available types)

| Туре                      | B3232 | 3323201 |      |      |     |     |      |      |
|---------------------------|-------|---------|------|------|-----|-----|------|------|
| Capacitors<br>height (mm) | 53    |         |      |      |     |     |      |      |
| V <sub>R</sub> (85 °C)    | 450   | 800     | 1100 | 1300 | 450 | 800 | 1100 | 1300 |
| dV/dt in V/μs             | 20    | 22      | 40   | 60   | 20  | 22  | 40   | 60   |
| Capacitors<br>height (mm) | 95    |         |      |      | 120 |     |      |      |
| V <sub>R</sub> (85 °C)    | 450   | 800     | 1100 | 1300 | 450 | 800 | 1100 | 1300 |
| dV/dt in V/μs             | 8     | 9       | 20   | 30   | 6   | 7.5 | 15   | 25   |

 $\hat{I}_{peak}$  (Peak current that can be handled by capacitor) =  $C(\mu F) \times dV/dt$ 



# **Metallized Polypropylene Film Capacitors (MKP)**

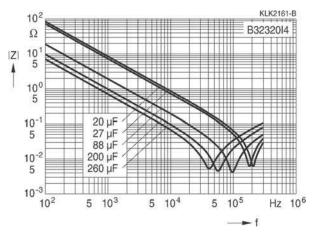
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## Characteristics curves (Z / ESR vs freq)

# Impedance Z versus frequency f

(Typical values)

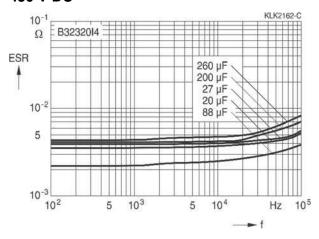
#### 450 V DC



## ESR versus frequency f

(Typical values)

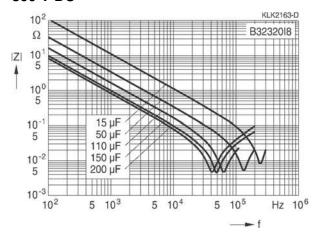
#### 450 V DC



## Impedance Z versus frequency f

(Typical values)

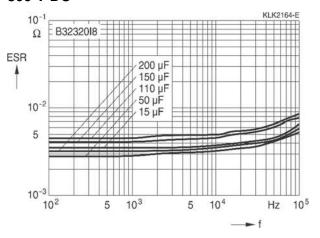
## 800 V DC



# ESR versus frequency f

(Typical values)

## 800 V DC





# **Metallized Polypropylene Film Capacitors (MKP)**

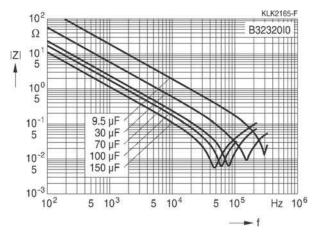
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## Characteristics curves (Z / ESR vs freq)

# Impedance Z versus frequency f

(Typical values)

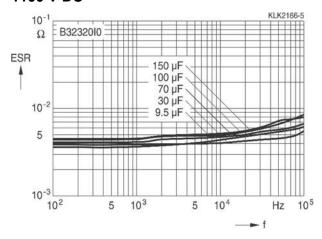
#### 1100 V DC



## ESR versus frequency f

(Typical values)

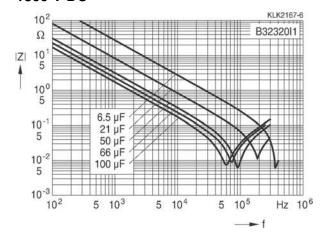
#### 1100 V DC



## Impedance Z versus frequency f

(Typical values)

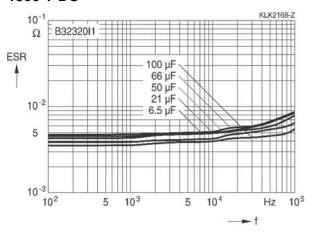
## 1300 V DC



# ESR versus frequency f

(Typical values)

## 1300 V DC



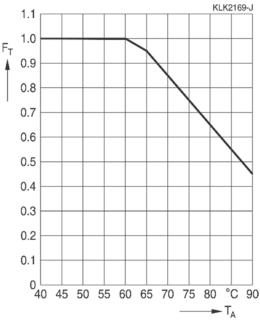


# **Metallized Polypropylene Film Capacitors (MKP)**

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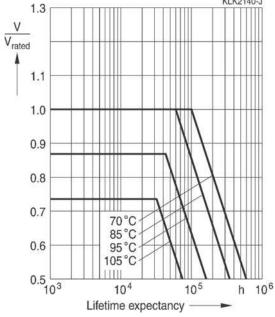
# $I_{\text{RMS}}$ derating vs $T_{\text{A}}$



Maximum I<sub>RMS</sub> current as function of the ambient temperature: I<sub>RMS</sub> (T<sub>A</sub>) = Factor × I<sub>RMS</sub> (60 °C)

#### Service life

Life time expectancy-typical curve B32320I (450 V DC / 800 V DC / 1100 V DC / 1300 V DC)



Note: Confidence level of 70%

CAP FILM I&A AC PD



# **Metallized Polypropylene Film Capacitors (MKP)**

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# **Testing and standards**

| Test   | Reference                                      | Conditions of test   |              | Performance requirements  |
|--|--|--|--------------|---|
| Electrical parameters (Routine test)  Robustness of terminations | IEC61071: 2007  IEC 60068-2-21: 2006           | Voltage between terminals, 1.5 V <sub>R</sub> , during 10 s Insulation resistance, R <sub>INS</sub> at V <sub>R</sub> if V <sub>R</sub> <500 V or 500 V if V <sub>R</sub> ≥500 V Capacitance, C at 1 kHz (room temperature) Dissipation factor, tan d at 1/10 kHz (room temperature) Tensile strength (test Ua1) |              | requirements  |
| (Type test)  |  | 0.8 <d1 mm<br="" ≤1.25="">&gt;1.25 mm</d1>   | 20 N<br>40 N |   |
| Resistance to soldering heat (Type test)                         | IEC 60068-2-20: 2008,<br>test Tb,<br>method 1A | Solder bath temperature at 260 ±5 °C, immersion for 10 seconds   |              | ΔC/C <sub>0</sub>   ≤2%<br> Δtan δ  ≤0.002<br>R <sub>INS</sub> ≥50% of initial limit<br>Mechanical:<br>No visible damage          |
| Rapid change<br>of temperature<br>(Type test)                    | IEC 61071: 2007                                | TA = lower category temperature TB = upper category temperature Five cycles, duration t = 30 min   |              | ΔC/C₀  ≤2%<br> Δtan δ  ≤0.002<br>R <sub>INS</sub> ≥50% of initial limit<br>Mechanical:<br>No visible damage                       |
| Vibration and shocks (Type test)                                 | IEC 61071: 2007                                | f = 10 Hz to 55 Hz a = ±0.35 mm  Test duration per axis = 10 frequency cycles  |              | Electrical:  ΔC/C₀  ≤0.5% at 1 kHz  Mechanical: No visible damage   |
| Climatic sequence (Type test)                                    | IEC 60384-16: 2005                             | Dry heat Tb / 16 h Damp heat cyclic, 1s +55 °C / 24 h / 95% d Cold Ta / 2 h Damp heat cyclic, 5 d +55 °C / 24h / 95% d   | 100% RH      | No visible damage $ \Delta C/C_0  \leq 3\%$ $ \Delta \tan \delta  \leq 0.001$ $R_{\text{INS}} \geq 50\% \text{ of initial limit}$ |



# Metallized Polypropylene Film Capacitors (MKP)

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| Test                                     | Reference          | Conditions of test  | Performance requirements   |
|--|--------------------|---|--|
| Damp heat<br>Steady state<br>(Type test) | IEC 60384-16: 2005 | Test Ca<br>40 °C / 93% RH / 56 days   | No visible damage<br> ΔC/C₀  ≤5%<br>I∆tan δ  ≤0.005<br>R <sub>INS</sub> ≥50% of initial limit                              |
| Endurance<br>(Type test)                 | IEC 61071: 2007    | +85 °C / 1.3 V <sub>R</sub> / 500 hours and 1000 discharges at 1.4 I <sub>R</sub> and +85 °C / 1.3 V <sub>R</sub> / 500 hours | No visible damage  ΔC/C₀  ≤3%  Δtan δ  0.015 (10 kHz) R <sub>INS</sub> ≥50% of initial limit Mechanical: No visible damage |



## **Metallized Polypropylene Film Capacitors (MKP)**

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#### **Cautions and warnings**

- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

| Topic  | Safety information   | Reference chapter "General technical information"  |
|--|--|--|
| Storage conditions                             | Make sure that capacitors are stored within the specified range of time, temperature and humidity conditions.  | 4.5 "Storage conditions"                           |
| Flammability                                   | Avoid external energy, such as fire or electricity (passive flammability), avoid overload of the capacitors (active flammability) and consider the flammability of materials.  | 5.3 "Flammability"                                 |
| Resistance to vibration                        | Do not exceed the tested ability to withstand vibration. The capacitors are tested to IEC 60068-2-6. EPCOS offers film capacitors specially designed for operation under more severe vibration regimes such as those found in automotive applications. Consult our catalog "Film Capacitors for Automotive Electronics". | 5.2 "Resistance to vibration"                      |
| Topic  | Safety information   | Reference chapter "Mounting guidelines"            |
| Soldering                                      | Do not exceed the specified time or temperature limits during soldering.   | 1 "Soldering"                                      |
| Cleaning                                       | Use only suitable solvents for cleaning capacitors.  | 2 "Cleaning"                                       |
| Embedding of capacitors in finished assemblies | When embedding finished circuit assemblies in plastic resins, chemical and thermal influences must be taken into account.  Caution: Consult us first, if you also wish to embed other uncoated component types!  | 3 "Embedding of capacitors in finished assemblies" |



## **Metallized Polypropylene Film Capacitors (MKP)**

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#### Soldering

#### Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20:2008, test Ta, method 1.

Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2:2007, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

| Solder bath temperature               | 235 ±5 °C   |
|---------------------------------------|---|
| Soldering time                        | 2.0 ±0.5 s  |
| Immersion depth                       | 2.0 +0/0.5 mm from capacitor body or seating plane              |
| Evaluation criteria:Visual inspection | Wetting of wire surface by new solder ≥90%, free-flowing solder |

#### Resistance to soldering heat

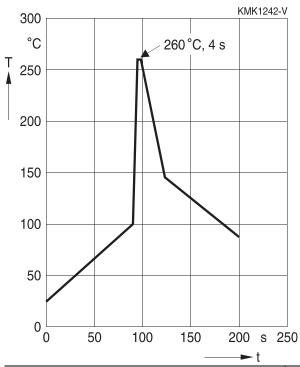
Resistance to soldering heat is tested to IEC 60068-2-20:2008, test Tb, method 1. Conditions:

| Series  | Solder bath temperature | Soldering time  |
|---|-------------------------|---|
| MKT boxed (except $2.5 \times 6.5 \times 7.2$ mm) coated uncoated (lead spacing >10 mm) | 260 ±5 °C               | 10 ±1 s   |
| MFP<br>MKP round can  |                         |   |
| MKT boxed (case 2.5 × 6.5 × 7.2 mm)   |                         | 5 ±1 s  |
| MKP (lead spacing ≤7.5 mm)  MKT uncoated (lead spacing ≤10 mm) insulated (B32559)       |                         | <4 s recommended soldering profile for MKT uncoated (lead spacing ≤ 10 mm) and insulated (B32559) |



## **Metallized Polypropylene Film Capacitors (MKP)**

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| Immersion depth                        | 2.0 +0/0.5 mm from capacitor body or seating plane                                       |
|--|--|
| Shield                                 | Heat-absorbing board, (1.5 $\pm$ 0.5) mm thick, between capacitor body and liquid solder |
| Evaluation criteria: Visual inspection | No visible damage  |
| $\Delta C/C_0$                         | 2% for MKT/MKP/MFP 5% for EMI suppression capacitors                                     |
| tan δ                                  | As specified in sectional specification  |

#### General notes on soldering

Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature  $T_{max}$ . Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics: diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings



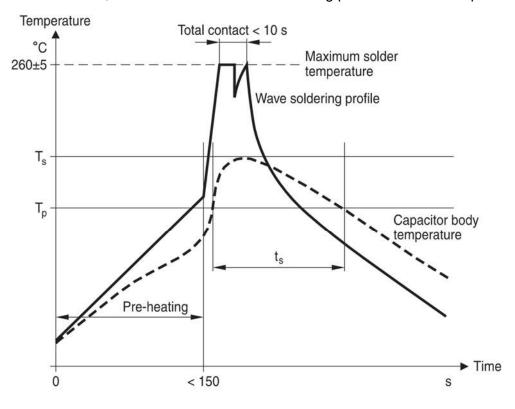
## **Metallized Polypropylene Film Capacitors (MKP)**

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The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

#### Recommendations

As a reference, the recommended wave soldering profile for our film capacitors is as follows:



T<sub>s</sub>: Capacitor body maximum temperature at wave soldering

T<sub>n</sub>: Capacitor body maximum temperature at pre-heating

KMK1745-A-E

Body temperature should follow the description below:

- MKP capacitor
  - During pre-heating: T<sub>p</sub> ≤110 °C
  - During soldering: T<sub>s</sub> ≤120 °C, t<sub>s</sub>≤45 s
- MKT capacitor
  - During pre-heating: T<sub>p</sub> ≤125 °C
  - During soldering: T<sub>s</sub> ≤160 °C, t<sub>s</sub> ≤45 s

When SMD components are used together with leaded ones, the film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.

Leaded film capacitors are not suitable for reflow soldering.

In order to ensure proper conditions for manual or selective soldering, the body temperature of the capacitor ( $T_s$ ) must be  $\leq 120$  °C.

One recommended condition for manual soldering is that the tip of the soldering iron should be <360 °C and the soldering contact time should be no longer than 3 seconds.



## Metallized Polypropylene Film Capacitors (MKP)

B323201

For uncoated MKT capacitors with lead spacings ≤10 mm, the following measures are recommended:

- pre-heating to not more than 110 °C in the preheater phase
- rapid cooling after soldering

#### Cleaning

To determine whether the following solvents, often used to remove flux residues and other substances, are suitable for the capacitors described, refer to the table below:

| Туре                            | Ethanol, isopropanol, n-propanol | n-propanol-water mixtures, water with surface tension-reducing tensides (neutral) |  |  |
|---------------------------------|----------------------------------|---|--|--|
| MKT<br>(uncoated)               | Suitable                         | Unsuitable  |  |  |
| MKT, MKP, MFP<br>(coated/boxed) |                                  | Suitable  |  |  |

Even when suitable solvents are used, a reversible change of the electrical characteristics may occur in uncoated capacitors immediately after they are washed. Thus it is always recommended to dry the components (e.g. 4 h at 70 °C) before they are subjected to subsequent electrical testing.

#### Caution:

Consult us first if you wish to use new solvents!

#### **Embedding of capacitors in finished assemblies**

In many applications, finished circuit assemblies are embedded in plastic resins. In this case, both chemical and thermal influences of the embedding ("potting") and curing processes must be taken into account.

Our experience has shown that the following potting materials can be recommended: non-flexible epoxy resins with acid-anhydride hardeners; chemically inert, non-conducting fillers; maximum curing temperature of 100 °C.

#### Caution:

Consult us first if you wish to embed uncoated types!

#### Marking

#### **Capacitor markings**

Depending on the capacitor size, the markings are positioned either on the side and/or the top of the component. The coded forms specified in IEC 60062:2004 are used to indicate the rated capacitance, capacitance tolerance and date of manufacture.

The lot number (production batch number) ensures unique identification of a particular capacitor and allows, together with the date of manufacture, exact assignment to the process data of the entire production run (traceability).



## **Metallized Polypropylene Film Capacitors (MKP)**

**B32320I** 

#### Marking examples

#### **Canned capacitors (without EMI suppression capacitors)**

| Style | Туре    | Marking example |                                       |     |           |  | Marking  |  |
|-------|---------|-----------------|---------------------------------------|-----|-----------|--|--|--|
| MKP   | B32320I |                 |                                       |     |           |  | Side stamping:   |  |
|       |         |                 | μF                                    | VDC | WW.YYN    |  | $\begin{array}{l} \text{Manufacturer's logo, } C_{R}, \\ \text{tolerance, } V_{R} \end{array}$ |  |
|       |         | TDK             | ±10%                                  | P   | .O Number |  |  |  |
|       |         | IDK             | B32320I                               |     | IEC 61071 |  |  |  |
|       |         | 5               | SH- No additional internal protection |     |           |  |  |  |
|       |         |                 |                                       |     |           |  |  |  |

## Marking types

The capacitors may have either an ink-jet marking or a laser marking. The main advantage of laser marking is that it cannot be removed by solvents, which ensures the reliable identification of the capacitor. Moreover, because the laser marking process reduces the amount of chemicals used, it is an environmentally friendly marking solution.

#### Display of ordering codes for TDK Electronics products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications, on the company website, or in order-related documents such as shipping notes, order confirmations and product labels. **The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products**. Detailed information can be found on the Internet under www.tdk-electronics.tdk.com/orderingcodes.

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The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule we are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether a product with the properties described in the product specification is suitable for use in a particular customer application.
- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
- 3. The warnings, cautions and product-specific notes must be observed.
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## Important notes

8. The trade names EPCOS, CarXield, CeraCharge, CeraDiode, CeraLink, CeraPad, CeraPlas, CSMP, CTVS, DeltaCap, DigiSiMic, ExoCore, FilterCap, FormFit, LeaXield, MiniBlue, MiniCell, MKD, MKK, ModCap, MotorCap, PCC, PhaseCap, PhaseCube, PhaseMod, PhiCap, PowerHap, PQSine, PQvar, SIFERRIT, SIFI, SIKOREL, SilverCap, SIMDAD, SiMic, SIMID, SineFormer, SIOV, ThermoFuse, WindCap, XieldCap are **trademarks registered or pending** in Europe and in other countries. Further information will be found on the Internet at www.tdk-electronics.tdk.com/trademarks.

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